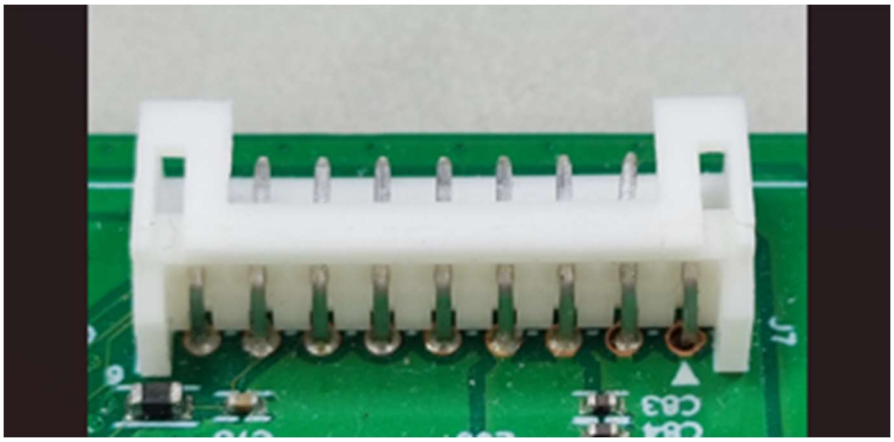




設計驗證
工程課
2025 -04- 28
發行

乔讯电子（上海）有限公司
Chyao Shiunn Electronics(Shang Hai) Co.,Ltd.

Specification For Approval

Customer	钰纬
Part No.	JS-1125R-09 (CM)
Customer Part No.	3FM00917210 (F0317)
Description	2.0mm pitch Connector
Samples	5 PCS

設計驗證
工程課
2025 -04- 28
發行
鈺緯科技開發股份有限公司

This Specification Is

Prepared By	Checked By	Approved By
Li Lian	Tang Nian	Tang Nian
Ini. Date	Rev. Date	Revision
2024.12.06	2024.12.06	A

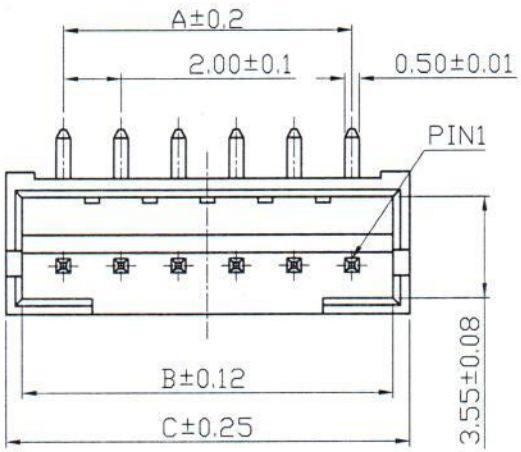
Address: Unit B,1/F, Block 46,No,299,Fu Te Chung Road Waigaoqiao Free Trade Zone,ShangHai China

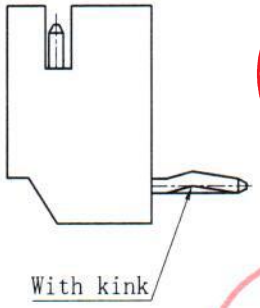
上海市外高桥保税区富特中路299号46号厂房

TEL: (86-21)-5046-1169,5046-1680 FAX:(86-21)5046-1063,5046-3014

E-mail:cssh@cssh.net.cn

REV	ECN. NO.	REVISIONS	REV. DRAWN	DATE
A	----	初版发行	cjg	2021.01.15





設計驗證
工程課
2025 -04- 28
發行
旺詮科技開發股份有限公司

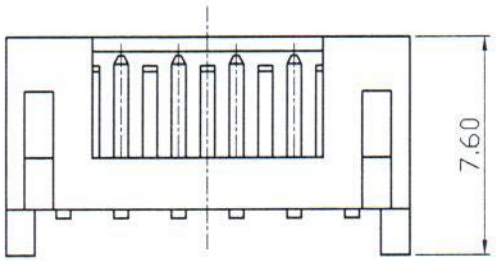
出图
2021.01.18
工程部

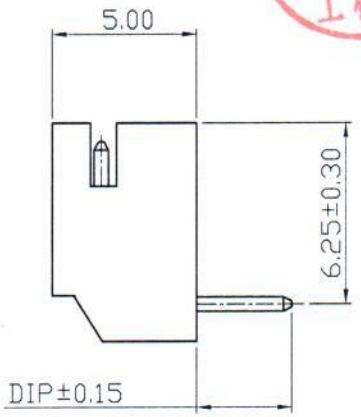
WAFER.

. Part No1: JS-1125R-XXXXXX-XXXX-NH

- Poles: 02~16
- Blank: Normal / K: Kink Foot
- Blank: DIP=3.30 / B: DIP=2.40 / C: DIP=2.30 / D: DIP=2.70
- (plating) Blank: Tin Plated / (M): Matte sn
- (materail) Blank: PA66 / D1:PA66+15%GF
- NH: Halogen Free / Blank: Normal
- Blank: Nature (color) / RD: Red / GN: Green / BK: Black / BU: Blue

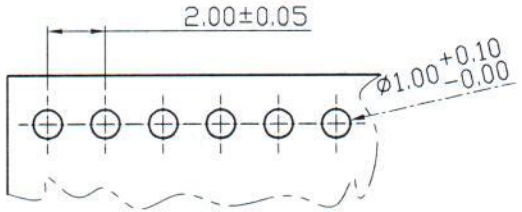
POLES	DIMENSION		
	A	B	C
02	2.00	4.85	6.00
03	4.00	6.85	8.00
04	6.00	8.85	10.00
05	8.00	10.85	12.00
06	10.00	12.85	14.00
07	12.00	14.85	16.00
08	14.00	16.85	18.00
09	16.00	18.85	20.00
10	18.00	20.85	22.00
11	20.00	22.85	24.00
12	22.00	24.85	26.00
13	24.00	26.85	28.00
14	26.00	28.85	30.00
15	28.00	30.85	32.00
16	30.00	32.85	34.00





SPECIFICATIONS :

. Voltage Rating : 100V AC/DC
. Current Rating : 2A AC/DC
. Withstanding Voltage : 800V AC/minute
. Insulation Resinstance : 1000MΩ min
. Temperature Range : -25° C~+85° C
. Contact Resinstance : 20mΩ max
. Material : Contact : Brass, Tin Plated/Matte sn
Base : Nylon, UL 94V-0
. Q'ty : Bag
. Halogen free product identification LOGO on the packing



P.C.B. Hole Diomensions

符合环境管理物质

X.± 0.30	X°± 3.0°	UNITS	mm
.X± 0.20	.X°± 1.0°	MAT'L	
.XX± 0.10	.XX°± 0.5°		
.XXX± 0.05	.XXX°± ---	FINISH	
Q'TY			

THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF CHYAO SHIUNN ELECTRONIC CO., LTD. AND SHALL NOT BE REPRODUCED COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF CHYAO SHIUNN ELECTRONIC CO., LTD.

NAME(INTENDED USE)	佳世达专用
PART NO.(INTENDED USE)	JS-1125R-XX
APP'D:	
CHK'D:	
DR:	CJG 2021.01.15

CHYAO SHIUNN ELECTRONIC (SHANGHAI) CO.,LTD.

TITLE: 2.00mm Crimp Style Connector

DWG NO.: 020-0013-1125R-03

SCALE	SHEET	REV.
4:1	1/1	A

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

This specification is referred to the 2.00mm DIP series wire to board connector.

2025-03-14 工程部

-INDEX-

1.0 Product Name/Part Number & Drawing Number. (产品名称 / 产品型号及图面型号)

2.0 Construction/Dimensions/Material & Surface Finish. (材质以及表面镀层)

3.0 Characteristic. (产品特性)

4.0 Specimen. (样本图标)

5.0 Applicable Standards. .(适用规范)

6.0 Mechanical Performance. (机械性能)

7.0 Electrical Performance. (电气性能)

8.0 Environmental Performance. (环境性能)

9.0 Insertion Force & Retention Force Requirement. (插入力和拔出力要求)

10.0 Remark. (备注)

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

1.0 Product Name/Part Number & Drawing Number(产品名称 / 产品型号及图面型号):

Product Name(产品名称)		Part Number (零件型号)	Drawing Number(图面型号)
Crimp Terminal (压接端子)		JS-1124-T XX	JS-1124-T XX
Housing		JS-1124-XX	JS-1124-XX
Wafer	Straight (直立式)	JS-1125-XX JS-1125B-XX	JS-1125X-XX
	Right Angle (卧式)	JS-1125R-XX	JS-1125R-XX

Note: (xx) The number of the circuits.

2.0 Construction/Dimensions/Material & Surface Finish(材质以及表面镀层):

Part Name(零件名称)		Material(材质)	Surface Finish(表面镀层)
Crimp Terminal (压接端子)		Phosphor Bronze (磷青铜))	Tin-Plated(Electroplating later stamping) 镀锡，先镀后冲
			Gold-Plated(Stamping later electroplating)镀金，先冲后镀
Housing		Nylon 66	UL 94V-0
Wafer	Square pin	Brass	Tin-Plated Matte-Plated Gold-Played (镀亮锡 或 镀雾锡或镀金)
	Base	Nylon 66/ Nylon 66+GF	UL 94V-0

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

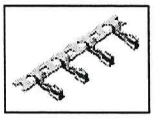
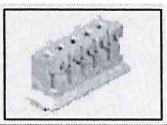
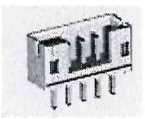
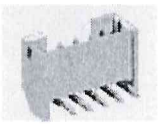
Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

东沛电子(上海)有限公司 2025-03-14 工程部

3.0 Characteristic（产品特性）：

Item(项目)		Standard（标准）	
3.1	Rated Current（额定电流）	2A AC/DC (With AWG #24 is applied)	
3.2	Ambient Temperature Range（环境温度范围）	Operating Temp. : -25℃~+85℃（工作温度:-25℃~+85℃）Including 30℃ Terminal Temperature Rise at rated Current ;（包括额定电流时30℃的终端温升。）	
3.3	Applicable Wire（适用电线）	3.3.1	Conductor Construction Size（金属导体型号）: AWG #24~#30
		3.3.2	Wire Insulation O.D. （电线绝缘外径）: 1.0mm~1.45mm
3.4	Applicable Printed Circuit Board Layout（适用印刷电路板布局）	3.4.1	Thickness: 0.8 mm ~ 1.6 mm
		3.4.2	Hole Size: 0.80±0.05 mm /$1.0^{+0.10}$mm
		3.4.3	Hole Pitch: 2.00 ± 0.05 mm

4.0 Specimen（样本图标）：

Part Name（零件名称）		Part Number（零件号）	Picture or Photograph（照片）
Crimp Terminal		JS-1124-T XX	
Housing		JS-1124-XX	
Wafer	Straight（直立式）	JS-1125-XX JS-1125B-XX	
	Right Angle（卧式）	JS-1125R-XX	

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

5.0 Applicable Standards:

MIL-STD-202 Methods by test of connectors for electronic equipment.
（MIL-STD-202 电子设备连接器试验方法）

EIA 364 Testing method for electrical connectors.
（EIA-364 电连接器试验方法。）

乔讯电子（上海）有限公司
2025-03-14
工程部

6.0 Mechanical Performance（机械性能）:

Item(项目)		Test Condition（测试条件）		Requirement（要求）
6.1	Insertion & Retention Force（插入力和拔出力）	Insert and withdraw with connectors at the speed rate of 25±3 mm/minute. (EIA 364-13)（连接器两端勘合，以每分钟 25±3 速率，作插入和拔出往返测试。）		Refer to paragraph 9.1（参考第 9.1 段）
6.2	Crimp Tensile Strength (Axial)（电线脱离端子包覆之拔出力）	Pull out the cable from contact terminal at the speed rate of 25± 3 mm/minute.（对端子所包覆电线，施以 25±3 mm/min 的速率轴向拔出。）	AWG#24 size wire	30N/Min.
			AWG#26 size wire	20N/Min.
			AWG#28 size wire	13N/Min.
			AWG#30 size wire	5N/Min.
6.3	Contact Retention Force (in Housing)（端子与胶座之间的拔出力）	Axial pullout force on the terminal in the housing at the speed rate of 25 ± 3 mm per minute.（对于已存在于胶座中端子，施以每分钟25±3 mm/min的速率之轴向拔出力。）		Per Contact 15N/Min.
6.4	Post Retention Force (in Base)（Pin 针保持力）	Axial pullout force on the square pin in the base at the speed rate of 25 ± 3mm per minute. (EIA 364-29C)（以25±3 mm/min的速度施加在塑壳方针上的轴向拔出力。）		Per Contact 10N/Min. After the solder Test : Per Contact 5N/Min.

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

7.0 Electrical Performance(电气性能):

Item(项目)		Test Condition（测试条件）	Requirement（要求）
7.1	Contact Resistance（接触阻抗）	A maximum voltage of 20mV and a maximum current of 10mA are applied to the Mate connectors. (EIA 364-23)（对组合状态下连接器，与其两端施以最大测试电压 20 mV 以及最大测试电流 10 mA。）	Contact Resistance: 20 milliohms Max.（接触电阻：最大 20mΩ）
7.2	Current Continuity（电流连续性）	Each circuit of the connector shall be connected in series continuity meter shall detect current discontinuity longer than 1 microsecond during the vibration test.（连接器的每个电路应串联连接，连续性计应在振动试验期间检测超过1微秒的电流不连续性。）	No discontinuity current is longer than 1 microsecond.（回路瞬间断电不能超过1微秒）
7.3	Insulation Resistance（绝缘阻抗）	Apply 500V D/C to any two adjacent contacts to measure the insulation resistance. (EIA 364-21)（对相邻两接触导体，在一分钟时间内施予 500V D/C 电压，并量测其间绝缘阻抗值）	Insulation Resistance: Initial 1000 megohms Min.（绝缘电阻：初始 1000 兆欧（最小值））
7.4	Withstanding Voltage（耐电压）	Apply 800V A/C (rms) for 1 minute and the leakage current shall not excced 0.5mA to the adjacent terminal and ground of the Mate connectors. (EIA 364-20)（对组合状态下连接器，与其相邻两导体未端各施以电压 800 A/C（实效值）时间一分钟.）	No breakdown or flashover.（无击穿或者火花）

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

8.0 Environmental Performance (环境性能) :

Item(项目)		Test Condition（测试条件）	Requirement（要求）
8.1	Durability （耐久性）	Mate Connectors up 50 Cycles at a Maximun rate of 10 cycles Per minute prior to environmental test (EIA/ECA 364-09C) （以组合状态下连接器且未经环境测试，以每分钟内进行 10 次插入与拔出之最大速率，连续 50 次插入与拔出往返测试。）	(After the test) Contact Resistance: 40 milliohms Max. （（测试后）接触电阻：最大 40 mΩ。）
8.2	Vibration （振动）	A mated connector shall be mounted on a printed Circuit board and subjected to a vibration test of the following conditions. During the test, test current continuity shall be checked. After the test, contact resistance shall be measured. 以组合状态下连接器焊接于电路板作为试验样品，依照如下规格,进行耐振动试验，试验过程确认是否产生不连续电流(断电)现象，并于试验过后量测其接触阻抗。 (EIA/ECA 364-28E-Condition Ⅰ) Frequency (频率): 10~55~10 Hz/minute. Amplitude (振幅): 1.5 mm P-P. Direction（方向）: 1. Axis of up and down. 上下轴向(Y 轴) 2. Axis of right the left. 左右轴向(X 轴) 3. Axis of front and back.前后轴向(Z 轴) Period: 2 hours for each direction. 时间:每一轴向持续 2 小时。	(After the test) Contact Resistance: 40 milliohms Max. （振动后测试，最大接触阻抗40 mΩ）
			(After the test) No discontinuity current is longer than 1 microsecond （振动后测试，电流中断时间不可多于 1 微秒）.

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

Item(项目)		Test Condition（测试条件）	Requirement（要求）
8.3	Humidity Steady State （恒温恒湿）	A mated connector shall be placed in a humidity chamber of the following conditions. After the test, the contact resistance, the insulation resistance and the dielectric withstanding voltage shall be measured. 以组合状态下连接器放置与恒定温度的湿气空间，依照如下规格要求， 进行恒温恒湿试验， 并于试验过程后量测其接触阻抗，绝緣阻抗，以及耐电压测试。 (EIA 364-31B Conditions III . Method A) Temperature(温度) : 40±2℃. Relative Humidity(相符湿度) : 90%~95% (RH). Period(周期) : 96 hours continuously. (持续 96 小时)	(After the test) Contact Resistance: 40 milliohms Max. （测试之后，最大接触阻抗40 mΩ）
			(After the test) Insulation Resistance: 500 Megohms Min. （测试之后，最小绝缘阻抗500 MΩ）
			(After the test) Withstanding Voltage : No breakdown or flashover （测试之后，耐电压：无击穿或者火花）
8.4	Thermal Shock （冷热冲击）	A mated connector shall be subjected to a thermal shock test of the following conditions. After the test, the contact resistance, the insulation resistance and the dielectric withstanding voltage shall be measured. 以组合状态下连接器作为实验样品， 照如下规格要求，进行冷热冲击试验，于试验过程后量测其接触阻抗，绝緣阻抗，以及耐电压测试 One Cycle Consists Of: -55 +0/-3℃for 30 minutes. → Room Temp.5 minutes 85+3/-0℃ for 30 minutes. → Room Temp.5 minutes Total Cycles: 5 Cycles.(EIA 364-32)一个循环包括： -55+0/-3℃30 分钟。→室温 5 分钟 85+3/-0℃30 分钟。→室温 5 分钟 总周期：5 个周期	Same as paragraph 8.2 （数据和图表8. 2一样）

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

Item(项目)		Test Condition（测试条件）	Requirement（要求）
8.5	Heat Aging 热老化	A mated connector shall be placed in a heat oven of the following conditions. After the test, contact resistance shall be measured. 以组合状态下连接器放置于加热烤箱中，依照如下规格要求，进行高温老化试验，并于试验后测量其接触电阻。 (EIA 364-17B Conditions III . Method A) Temperature: 85±2℃. 温度：85±2℃。 Period: 96 hours continuously.周期：连续 96 小时。	(After the test) Contact Resistance: 40 milliohms Max. （测试之后，接触电阻最大40 mΩ）
8.6	Salt Spray （盐雾）	A mated connector shall be subjected to a Salt Spray test of the following conditions. After the test , the specimen shall be washed with running water and dried naturally before the measurement of contact resistance. Temperature: 35±2℃. Density: 5 % in weight. Period: Terminal or contact (Stamping after tin plated for 8 hours) ; Terminal or contact (Stamping before tin plated for 24 hours) Salt spray test only define the plating area,without plating area(as copper cross section)will not be define. (EIA 364-26) （以组合状态下连接器作为试验样品，依照随附如下规格要求，进行盐水喷雾试验，试验过后将样品用清水冲洗并经过自然风干，而后测量其接触接触阻抗 温度：35±2℃。 盐水浓度：重量的 5%。 时间：端子（先镀后冲，8小时）& 端子（先冲后镀，24 小时）） 盐水喷雾测试只判定电镀区域，无电镀区域（如折断面裸铜）则不作判定.	(After the test) Contact Resistance: 40 milliohms Max （测试之后，接触电阻最大 40 mΩ）

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

Item(项目)		Test Condition（测试条件）	Requirement（要求）
8.7	Solder Ability （焊锡性）	Fluxed soldering section of header shall be dipped in solder Solder entirely 95% of of the following conditions. (EIA 364-52B)将连接器 pin 针基板嵌入端，接触热溶状锡料，照如下规格要求， 进行焊锡性试验 Solder Temperature: 245 ± 5℃. Immersion Period: 3±0.5 Seconds Method : 1.5mm From Square Pin Tip. (EIA 364-52) 焊接温度：245±5℃。 浸泡时间：3±0.5 秒 方法：零件焊锡位置，距离导体末端1.5mm。	Solder entirely 95% of immersed area must show no voids or pinholes. （焊料浸没区域的 95%不得有空隙或针孔）
8.8	Resistance To Soldering Heat （焊锡耐热性）	Resistance to soldering heat when using PA66(G.F.): Solder Temperature: 255 ± 5℃. Immersion Period : 3~5±0.5 Seconds (The part can't suitable to pass the IR reflow) （使用PA66(G.F.) 耐焊接热性： 焊接温度：255±5℃。 浸泡时间：3~5±0.5秒 （零件不适合通过IR回流焊)）	There shall be no deformation or damage which may affect the performance. （不得有可能影响性能的变形或损坏。）
		By soldering iron:350 ± 5℃ 3±0.5 Seconds. Method : 1.5mm From Square Pin Tip （通过烙铁：350±5℃ ，3±0.5秒。 方法：距方针端部 1.5mm）	

喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.
TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

ISO 9002

Type Document	Product Specification	Revised / Edition	K
Date Issued	2004/08/23	Data Revised	2025/03/13
Subject: JS-1124 JS-1124-T JS-1125 JS-1125R Pitch 2.00mm DIP Series Wire to Board Connector			Issued By: Engineering Dept.

2025-03-14

9.0 Insertion Force (I.F.) & Retention Force (R.F.) (插入力和拔出力)

9.1 Requirement（要求）:

No. Of Circuits	AT INITIAL		AT 50TH	No. Of Circuits	AT INITIAL		AT 50TH
	I.F. (MAX)	R.F. (MIN)	R.F. (MIN)		I.F. (MAX)	R.F. (MIN)	R.F. (MIN)
				11	70	16	14
02	15	3.0	2.5	12	75	18	16
03	25	6.0	5.0	13	80	20	18
04	35	8.0	6.0	14	80	20	18
05	40	10.0	8.0	15	100	25	20
06	45	12.0	10.0	16	100	25	20
07	50	12.0	10.0				
08	55	14.0	12.0				
09	60	14.0	12.0				
10	65	16.0	14.0				

Unit: N

10.0 Remark: Any change or revision for the product specification will not be announced in advance. Please contact our sales representative for the latest information.

（备注：产品规格如有变更或修订，恕不另行通知。有关最新信息，请与我们的销售代表联系。）